

Product Summary

Device	V _{RRM} (V)	I _O (A)	V _F Max (V) @ +25°C	I _R Max (mA) @ +25°C
B370BE/CE	70	3.0	0.79	0.10
B380BE/CE	80	3.0	0.79	0.15
B390BE/CE	90	3.0	0.79	0.20
B3100BE/CE	100	3.0	0.79	0.30

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

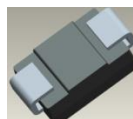
Mechanical Data

- Case: SMB, SMC
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (63)
- Polarity: Cathode Band
- Weight: SMB- 0.093 grams (Approximate)
SMC- 0.21 grams (Approximate)

SMB, SMC



Top View



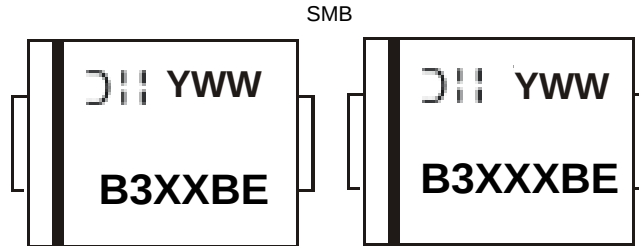
Bottom View

Ordering Information (Notes 4 and 5)

Part Number	Case	Packaging	Status	Replacement
B370BE-13	SMB	3,000/Tape & Reel	NRND	B370B-13-F
B370CE-13	SMC	3,000/Tape & Reel	NRND	B370-13-F
B380BE-13	SMB	3,000/Tape & Reel	NRND	B380B-13-F
B380CE-13	SMC	3,000/Tape & Reel	NRND	B380-13-F
B390BE-13	SMB	3,000/Tape & Reel	NRND	B390B-13-F
B390CE-13	SMC	3,000/Tape & Reel	NRND	B390-13-F
B3100BE-13	SMB	3,000/Tape & Reel	Active	—
B3100CE-13	SMC	3,000/Tape & Reel	NRND	B3100-13-F

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
 5. NRND = Not recommended for new design.

Marking Information



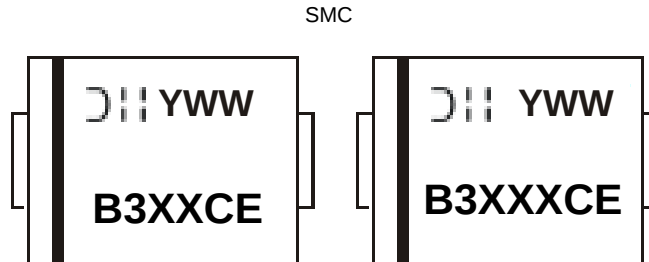
B3XXBE or B3XXXBE = Product Type Marking Code, ex: B370BE

YWW = Manufacturers' Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 0 for 2020)

WW = Week Code (01 to 53)



B3XXCE or B3XXXCE = Product Type Marking Code, ex: B370CE

YWW = Manufacturers' Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 0 for 2020)

WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	B370BE B370CE	B380BE B380CE	B390BE B390CE	B3100BE B3100CE	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	70	80	90	100	V
Working Peak Reverse Voltage	V _{RWM}					
DC Blocking Voltage	V _{RM}					
Average Rectified Output Current	I _O	3				A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	100				A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	90	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	70	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	50	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	30	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.74	0.79	V	I _F = 3A, T _A = +25°C
		—	0.60	—		I _F = 3A, T _A = +125°C
Leakage Current (Note 7)	I _R	—	—	0.10	mA	V _R = 70V, T _A = +25°C
		—	—	0.15		V _R = 80V, T _A = +25°C
		—	—	0.20		V _R = 90V, T _A = +25°C
		—	—	0.30		V _R = 100V, T _A = +25°C
		—	0.7	—		V _R = 100V, T _A = +125°C
Typical Capacitance	C _T	—	105	—	pF	V _R = 4.0V, f = 1MHz

Notes: 6. Device mounted on FR-4 substrate, 1"×1", 2oz, single-sided, PC boards with 0.56"×0.73" copper pad.
 7. Short duration pulse test used to minimize self-heating effect.

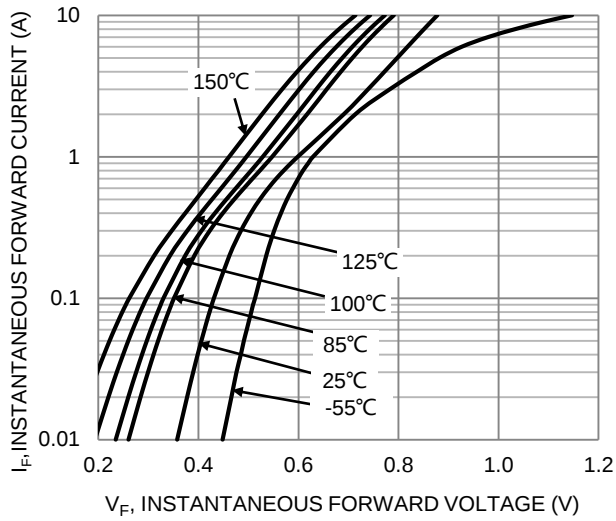


Figure 1. Typical Forward Characteristics

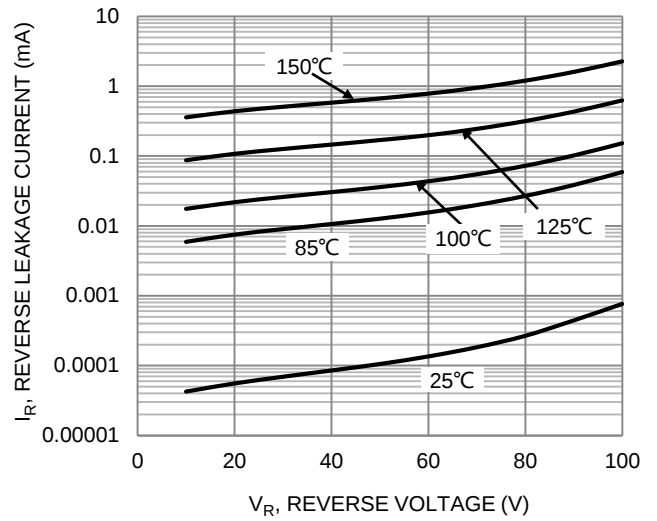


Figure 2. Typical Reverse Characteristics

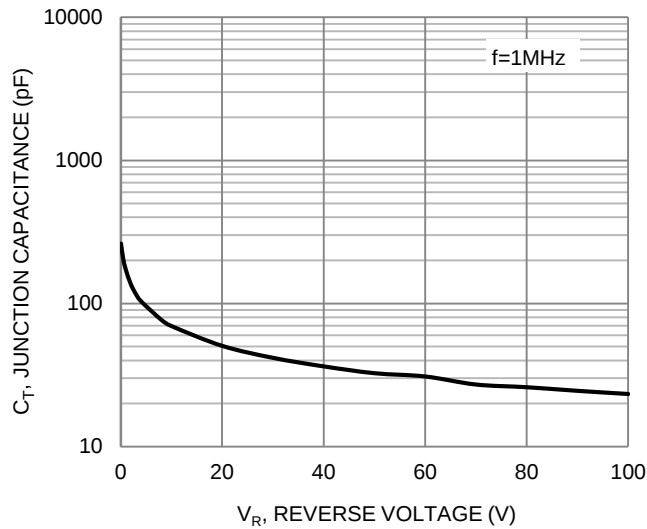


Figure 3. Typical Junction Capacitance

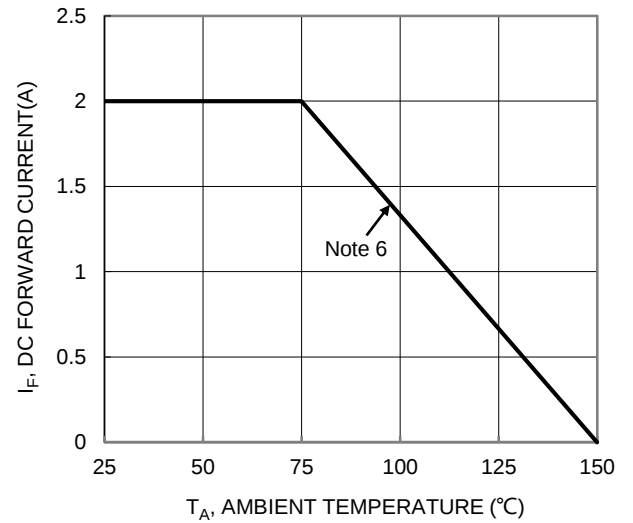
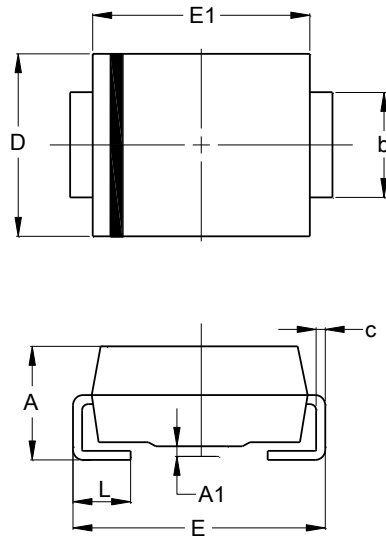


Figure 4. DC Forward Current Derating

Package Outline Dimensions

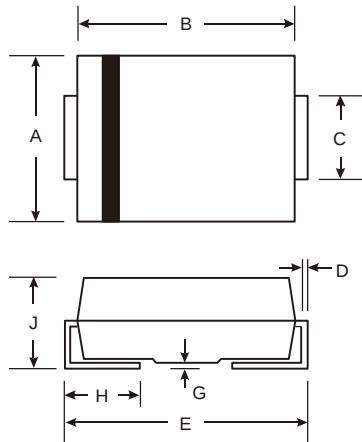
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SMB



SMB		
Dim	Min	Max
A	2.00	2.50
A1	0.05	0.20
b	1.96	2.21
c	0.15	0.31
D	3.30	3.94
E	5.00	5.59
E1	4.06	4.57
L	0.76	1.52
All Dimensions in mm		

SMC

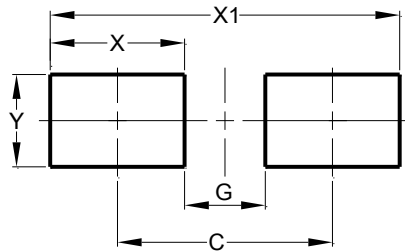


SMC		
Dim	Min	Max
A	5.59	6.22
B	6.60	7.11
C	2.75	3.18
D	0.15	0.31
E	7.75	8.13
G	0.10	0.20
H	0.76	1.52
J	2.00	2.50
All Dimensions in mm		

Suggested Pad Layout

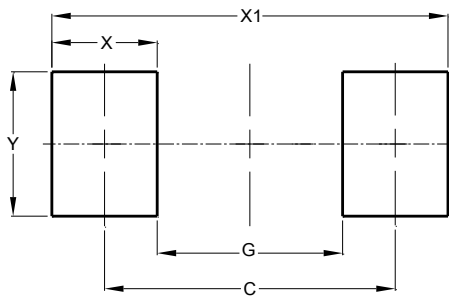
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SMB



Dimensions	Value (in mm)
C	4.30
G	1.80
X	2.50
X1	6.80
Y	2.30

SMC



Dimensions	Value (in mm)
C	6.90
G	4.40
X	2.50
X1	9.40
Y	3.30

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